






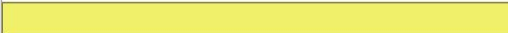






# Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Component Side	Copper	0.047mm	
5		Dielectric1	R1650V	0.110mm	4.2
6		Inner1	Copper	0.018mm	
7		Dielectric2	R-1755V	0.100mm	4.2
8		Inner2	Copper	0.018mm	
9		Dielectric3	R1650V	0.110mm	4.2
10		Inner3	Copper	0.018mm	
11		Dielectric4	R-1755V	0.100mm	4.2
12		Inner4	Copper	0.018mm	
13		Dielectric5	R1650V	0.110mm	4.2
14		Solder Side	Copper	0.047mm	
15		Bottom Solder	Solder Resist	0.010mm	3.5
16		Bottom Overlay			
17		Bottom Paste			
	Height : 0.716mm				